

IAW



Attorney Docket No. 5649-1123

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Jung et al.	Group Art Unit: 2829
Serial No.: 10/650,415	Examiner: Asok K. Sarkar
Filed: August 28, 2003	Confirmation No.: 6569
For: POST THERMAL TREATMENT METHODS OF FORMING HIGH DIELECTRIC LAYERS IN INTEGRATED CIRCUIT DEVICES	

Date: September 23, 2004

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

Applicants provide the present Amendment to address the issues raised in the Official Action mailed June 24, 2004, pursuant to the rules stated in revised 37 C.F.R. 1.121 that became effective on July 30, 2003.

Amendments to the Claims are reflected in the listing of claims, which begins on page 2 of this paper.

Remarks begin on page 8 of this paper.